UMW SD05.TCT

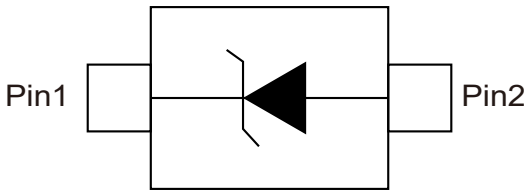
1.Features

- 360W peak pulse power (tp = 8/20μs)
- Unidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- IEC 61000-4-2 ±30kV contact ±30kV air
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 20A (8/20μs)

2.Applications

- USB Vbus,
- Power Line
- Power management
- SOD323 package
- Packaging: Tape and Reel
- RoHS/WEEE Compliant
- Molding compound flammability rating: UL94V-0

3.Pinning information



SOD-323

4.Absolute Maximum Ratings T_A= 25°C

Parameter	Symbol	Maximum	Units
Peak Pulse Power (tp=8/20μs)	P_{PP}	360	W
Peak Pulse Current (tp=8/20μs) (note1)	I_{PP}	20	A
ESD per IEC 61000-4-2 (Air)	V_{ESD}	30	kV
ESD per IEC 61000-4-2 (Contact)		30	kV
Lead Soldering Temperature	T_L	260(10seconds)	°C
Junction Temperature	T_J	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C

5.Electrical Characteristic (T_A=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Reverse Stand-Off Voltage	V_{RWM}				5	V
Reverse Breakdown Voltage	V_{BR}	I_T=1mA	6			V
Reverse Leakage Current	I_R	V_{RWM}=5V, T=25°C			1	μA
Clamping Voltage	V_C	I_{PP}=20A, t_p=8/20μs		17	19	V
Junction Capacitance	C_J	V_R=0V, f=1MHz		120	135	pF

6.Typical characteristic

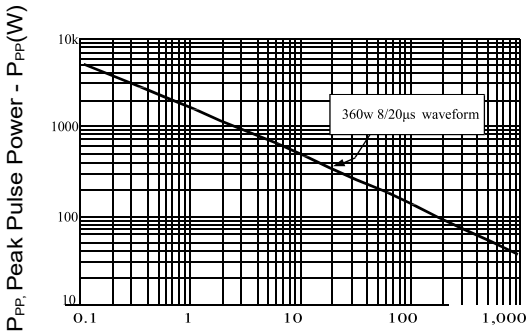


Figure 1: Peak Pulse Power vs. Pulse Time

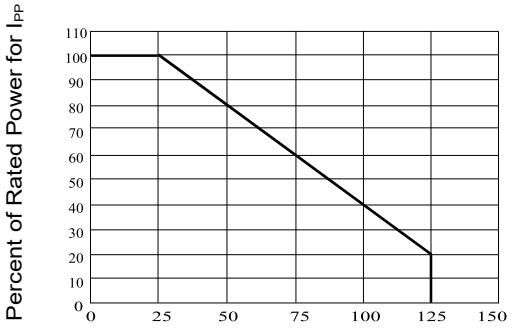


Figure 2: Power Derating Curve

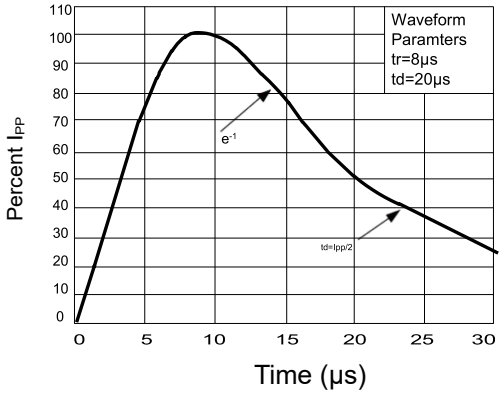


Figure 3: Pulse Waveform

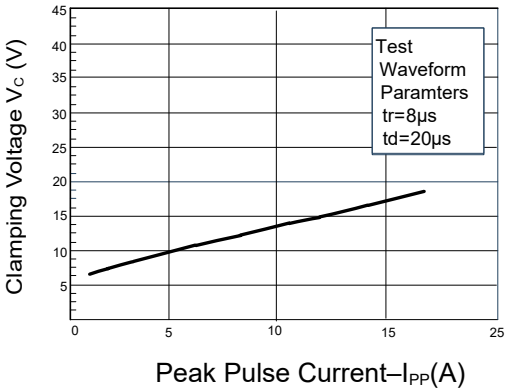
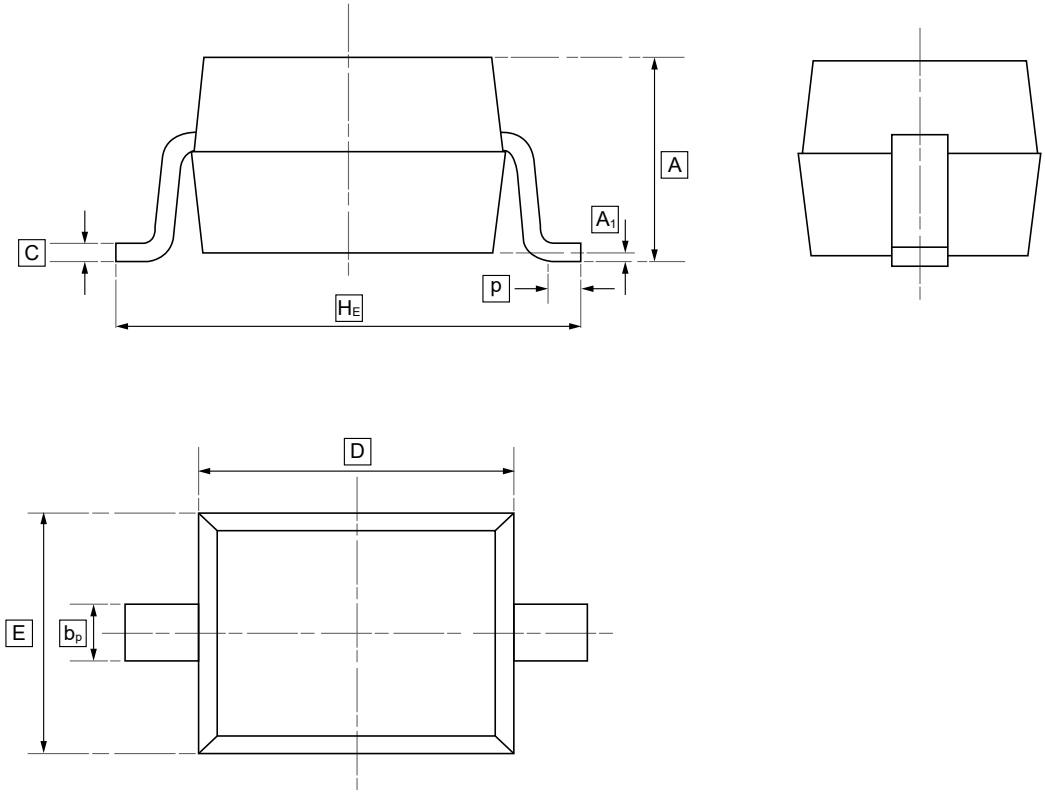


Figure 4: Clamping Voltage vs.I_{PP}

7.SOD-323 Package Outline Dimensions



DIMENSIONS (mm are the original dimensions)

Symbol	A	b_p	C	D	E	H_E	A_1	p
Min	0.80	0.25	0.10	1.50	1.15	2.30	0.01	0.20
Max	1.20	0.40	0.15	1.80	1.35	2.80	0.10	0.50

8.Ordering information



ww: Batch Code

Order Code	Package	Base QTY	Delivery Mode
UMW SD05.TCT	SOD-323	3000	Tape and reel

9.Disclaimer

UMW reserves the right to make changes to all products, specifications. Customers should obtain the latest version of product documentation and verify the completeness and currency of the information before placing an order.

When applying our products, please do not exceed the maximum rated values, as this may affect the reliability of the entire system. Under certain conditions, any semiconductor product may experience faults or failures. Buyers are responsible for adhering to safety standards and implementing safety measures during system design, prototyping, and manufacturing when using our products to prevent potential failure risks that could lead to personal injury or property damage.

Unless explicitly stated in writing, UMW products are not intended for use in medical, life-saving, or life-sustaining applications, nor for any other applications where product failure could result in personal injury or death. If customers use or sell the product for such applications without explicit authorization, they assume all associated risks.

When reselling, applying, or exporting, please comply with export control laws and regulations of China, the United States, the United Kingdom, the European Union, and other relevant countries, regions, and international organizations.

This document and any actions by UMW do not grant any intellectual property rights, whether express or implied, by estoppel or otherwise. The product names and marks mentioned herein may be trademarks of their respective owners.